

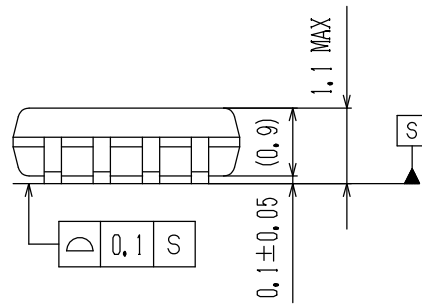
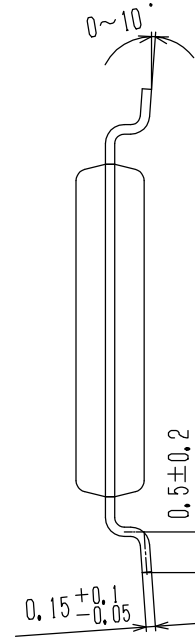
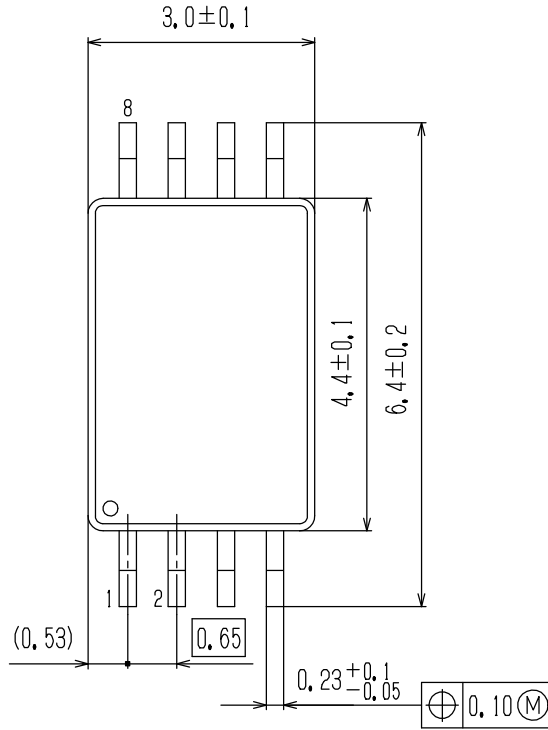
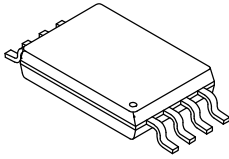
**MECHANICAL CASE OUTLINE**  
**PACKAGE DIMENSIONS**

ON Semiconductor®



**TSSOP8 3x4.4 / TSSOP8 (225 mil)**  
**CASE 948BH**  
**ISSUE O**

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<b>NEW STANDARD:</b>		
<b>DESCRIPTION:</b>	<b>TSSOP8 3X4.4 / TSSOP8 (225 MIL)</b>	<b>PAGE 1 OF 2</b>

